

#### 30V N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

V <sub>(BR)DSS</sub>	Max R <sub>DS(ON)</sub>	Max I <sub>D</sub> T <sub>A</sub> = +25°C
30V	0.050Ω @ V <sub>GS</sub> = 10V	4.6A

## **Description and Applications**

This new generation of TRENCH MOSFET from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.

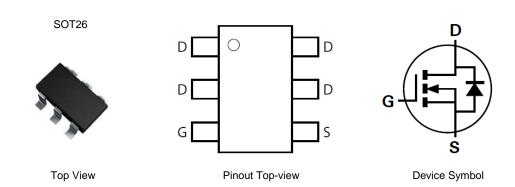
- DC DC converters
- **Power Management Functions**
- **Disconnect Switches**
- Motor Control

## **Features and Benefits**

- Low On-resistance
- Fast Switching Speed
- Low Threshold
- Low Gate Drive
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.015 grams (Approximate)



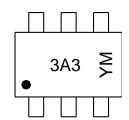
## **Ordering Information** (Note 4)

Part Number	Reel Size (inch)	Tape Width (mm)	Quantity Per Reel
ZXMN3A03E6TA	7	8	3000
ZXMN3A03E6TC	13	8	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



3A3 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: C = 2015) M or  $\overline{M}$  = Month (ex: 9 = September)

Date Code Key

Year	201	5	2016	2017	2018	2019	2020	202	1 20	22 2	2023	2024	2025
Code	С		D	Е	F	G	Н	- 1	,	J	K	L	М
Monti	h	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	;	1	2	3	4	5	6	7	8	9	0	N	D

1 of 7 ZXMN3A03E6 March 2015 Datasheet Number: DS33531 Rev. 4 - 2 © Diodes Incorporated



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			V <sub>DSS</sub>	30	V	
Gate-Source Voltage			V <sub>GS</sub>	±20	V	
		T <sub>A</sub> = +25°C (Note 6)		4.6		
Continuous Drain Current	$V_{GS} = 10V$	$T_A = +70^{\circ}C \text{ (Note 6)}$	I <sub>D</sub>	3.7	Α	
		$T_A = +25^{\circ}C \text{ (Note 5)}$		3.7		
Pulsed Drain Current (Note 7)			I <sub>DM</sub>	17	Α	
Continuous Source Current (Body Diode) (Note 6)			I <sub>S</sub>	2.6	А	
Pulsed Source Current (Body Diode) (Note 7)			I <sub>SM</sub>	17	А	

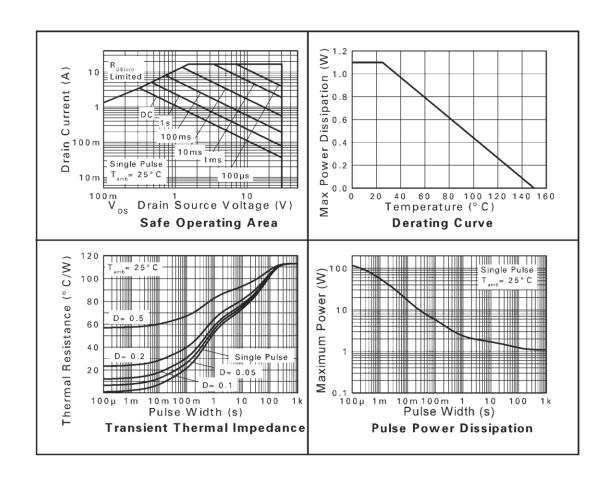
# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation at $T_A = +25^{\circ}C$ (Note 5) Linear derating factor (Note 5)	P <sub>D</sub>	1.1 8.8	W mW/°C
Power Dissipation at $T_A = +25^{\circ}C$ (Note 6) Linear derating factor (Note 6)	P <sub>D</sub>	1.7 13.6	W mW/°C
Junction to Ambient (Note 5)	$R_{ hetaJA}$	113	°C/W
Junction to Ambient (Note 6)	$R_{ heta JA}$	73	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes:

- 5. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
- 6. For a device surface mounted on FR-4 PCB measured at t ≤ 10 secs.
- 7. Repetitive rating 25mm x 25mm FR-4 PCB, D = 0.05, pulse width 10µs pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.

### Thermal Characteristics





# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$I_D = 250 \mu A, V_{GS} = 0V$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	0.5	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Gate-body Leakage	I <sub>GSS</sub>	1	_	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS						
Gate-source Threshold Voltage	$V_{GS(th)}$	1		_	V	$I_D = 250 \mu A, V_{DS} = V_{GS}$
Static Drain-source On-state Resistance (Note 8)	R <sub>DS</sub> (ON)	_	_	0.050	Ω	$V_{GS} = 10V, I_D = 7.8A$
Statio Brain source on state resistance (Note o)	INDS (ON)			0.065	32	$V_{GS} = 4.5V, I_D = 6.8A$
Forward Transconductance (Notes 8 & 10)	g <sub>fs</sub>	l	10	_	S	$V_{DS} = 10V, I_D = 7.8A$
Diode Forward Voltage (Note 8)	$V_{SD}$	1	0.85	0.95	V	$T_J = +25^{\circ}C$ , $I_S = 3.2A$ , $V_{GS} = 0V$
DYNAMIC CHARACTERISTICS (Notes 9 & 10)						
Input Capacitance	Ciss	1	600	_	pF	\/ OF\/ \/ O\/
Output Capacitance	Coss	_	104	_	pF	$V_{DS} = 25V, V_{GS} = 0V$ -f = 1MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	-	58.5	_	pF	1 = 1101112
Gate Charge	Qg	1	6.9	_	nC	$V_{GS} = 5V, V_{DS} = 15V$ $I_D = 3.5A$
Total Gate Charge	Qg	l	12.6	_	nC	\/ 40\/ \/ 45\/
Gate-source Charge	$Q_{gs}$		2.0	_	nC	$V_{GS} = 10V, V_{DS} = 15V$ -In = 3.5A
Gate-drain Charge	$Q_{gd}$	1	2.0	_	nC	ID = 3.5A
Reverse Recovery Time (Note 10)	t <sub>rr</sub>	_	18.8	_	ns	$T_J = +25^{\circ}C, I_F = 3.5A,$
Reverse Recovery Charge (Note 10)	Q <sub>rr</sub>	_	14.1	_	nC	di/dt= 100A/µs
Turn-on Delay Time	t <sub>d(on)</sub>	_	2.9	_	ns	
Turn-on Rise Time	t <sub>r</sub>	_	6.4	_	ns	V <sub>DD</sub> = 15V, V <sub>GS</sub> = 10V
Turn-off Delay Time	t <sub>d(off)</sub>	-	16.0	_	ns	$I_D = 3.5A, R_G = 6.0\Omega$
Turn-off Fall Time	t <sub>f</sub>		11.2	_	ns	

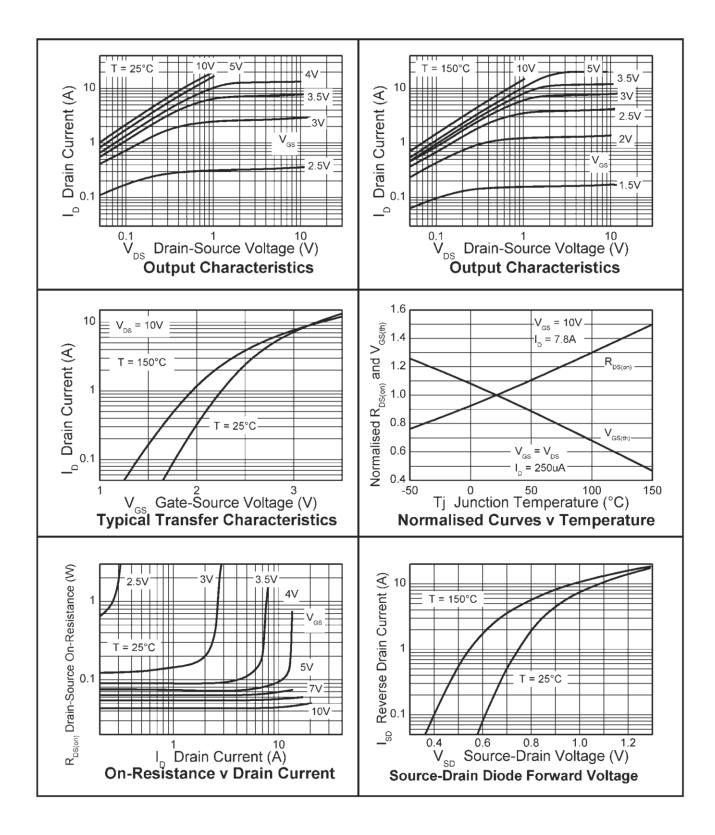
Notes:

- 8. Measured under pulsed conditions. Width=300µs. Duty cycle ≤ 2%.
  9. Switching characteristics are independent of operating junction temperature.
  10. For design aid only, not subject to production testing.

March 2015

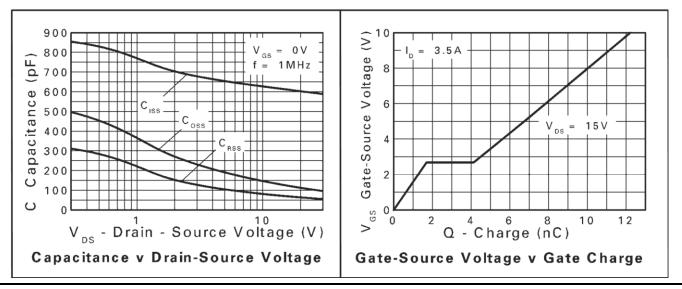


# **Typical Characteristics**

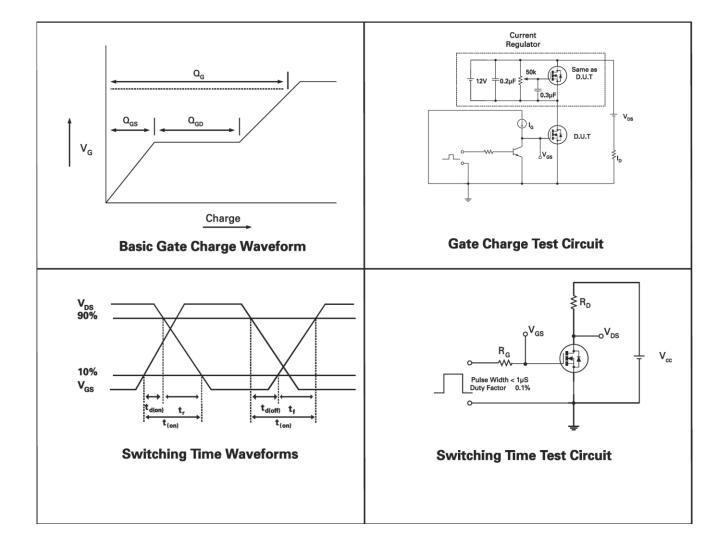




# Typical Characteristics (Cont.)



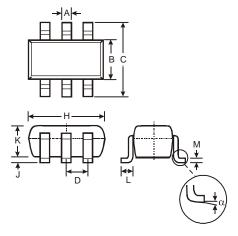
### **Test Circuits**





# **Package Outline Dimensions**

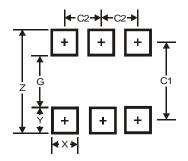
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT26						
Dim	Min	Max	Тур			
Α	0.35	0.50	0.38			
В	1.50	1.70	1.60			
С	2.70	3.00	2.80			
D	_	_	0.95			
Н	2.90	3.10	3.00			
J	0.013	0.10	0.05			
K	1.00	1.30	1.10			
L	0.35	0.55	0.40			
M	0.10	0.20	0.15			
α	0°	8°				
All Dimensions in mm						

# **Suggested Pad Layout**

 $Please\ see\ AP02001\ at\ http://www.diodes.com/datasheets/ap02001.pdf\ for\ the\ latest\ version.$ 



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Υ	0.80
C1	2.40
C2	0.95



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